## 256K x 18 Synchronous 3.3V Cache RAM

## Features

- Supports 117-MHz microprocessor cache systems with zero wait states
- 256K by 18 common I/O
- Low Standby Power ( 6.6 mW , L version)
- Fast clock-to-output times
-7.5 ns (117-MHz version)
- Two-bit wrap-around counter supporting either interleaved or linear burst sequence
- Separate processor and controller address strobes provides direct interface with the processor and external cache controller
- Synchronous self-timed write
- Asynchronous output enable
- I/Os capable of 2.5-3.3V operation
- JEDEC-standard pinout
- 100-pin TQFP packaging
- ZZ "sleep" mode


## Functional Description

The CY7C 1325 is a 3.3 V 256 K by 18 synchronous cache RAM designed to interface with high-speed microprocessors with minimum glue logic. Maximum access delay from clock rise is 7.5 ns (117-MHz version). A 2 -bit on-chip counter captures the first address in a burst and increments the address automatically for the rest of the burst access.
The CY7C1325 allows both an interleaved or linear burst sequences, selected by the MODE input pin. A HIGH selects an interleaved burst sequence, while a LOW selects a linear burst sequence. Burst accesses can be initiated with the processor address strobe ( $\overline{\mathrm{ADSP}}$ ) or the cache controller address strobe (ADSC) inputs. Address advancement is controlled by the address advancement (ADV) input.
A synchronous self-timed write mechanism is provided to simplify the write interface. A synchronous chip enable input and an asynchronous output enable input provide easy control for bank selection and output three-state control.

## Logic Block Diagram



## Selection Guide

|  | 7C1325-117 | 7C1325-100 | 7C1325-80 | 7C1325-50 |
| :--- | :---: | :---: | :---: | :---: |
| Maximum Access Time (ns) | 7.5 | 8.0 | 8.5 | 11.0 |
| Maximum Operating Current (mA) | 350 | 325 | 300 | 250 |
| Maximum Standby Current (mA) | 2.0 | 2.0 | 2.0 | 2.0 |

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## 100-Lead TQFP



## Functional Description (continued)

## Single Write Accesses Initiated by $\overline{\text { ADSP }}$

This access is initiated when the following conditions are satisfied at clock rise: (1) $\mathrm{CE}_{1}, \mathrm{CE}_{2}$, and $\mathrm{CE}_{3}$ are all asserted active, and (2) $\overline{\text { ADSP }}$ is asserted LOW. The addresses presented are loaded into the address register and the burst counter/control logic and delivered to the RAM core. The write inputs ( $\overline{\mathrm{GW}}, \overline{\mathrm{BWE}}$, and $\overline{\mathrm{BWS}}_{[1: 0]}$ ) are ignored during this first clock cycle. If the write inputs are asserted active (see write table for appropriate states that indicate a write) on the next clock rise, the appropriate data will be latched and written into the device. Byte writes are allowed. During byte writes, $\overline{\mathrm{BWS}}_{0}$ controls $\mathrm{DQ}_{[7: 0]}$ and $\mathrm{DP}_{0}$ while $\overline{\mathrm{BWS}}_{1}$ controls $\mathrm{DQ}_{[15: 8]}$ and $\mathrm{DP}_{1}$. All I/Os are three-stated during a byte write. Since these are common I/O device, the asynchronous $\overline{\mathrm{OE}}$ input signal must be deasserted and the I/Os must be three-stated prior to the presentation of data to $\mathrm{DQ}_{[15: 0]}$ and $\mathrm{DP}_{[1: 0]}$. As a safety precaution, the data lines are three-stated once a write cycle is detected, regardless of the state of $\overline{\mathrm{OE}}$.

## Single Write Accesses Initiated by $\overline{\text { ADSC }}$

This write access is initiated when the following conditions are satisfied at clock rise: (1) $\overline{C E}_{1}, C E_{2}$, and $\overline{C E}_{3}$ are all asserted active, (2) $\overline{\text { ADSC }}$ is asserted LOW, (3) $\overline{\mathrm{ADSP}}$ is deasserted HIGH, and (4) The write input signals ( $\overline{G W}$, BWE, and $\left.\overline{\mathrm{BWS}}_{[1: 01}\right)$ indicate a write access. $\overline{\mathrm{ADSC}}$ is ignored if $\overline{\mathrm{ADSP}}$ is active LOW.
The addresses presented are loaded into the address register, burst counter/control logic and delivered to the RAM core. The information presented to $\mathrm{DQ}_{[15: 0]}$ and $\mathrm{DP}_{[1: 0]}$ will be written into the specified address location. Byte writes are allowed, with $\overline{\mathrm{BWS}}_{0}$ controlling $\mathrm{DQ}_{[7: 0]}$ and $\mathrm{DP}_{0}$ while $\overline{\mathrm{BWS}}_{1}$ controlling $D Q_{[15: 8]}$ and $D P_{1}$. All I/Os are three-stated when a write is detected, even a byte write. Since these are common I/O device, the asynchronous $\overline{\mathrm{OE}}$ input signal must be deasserted and the I/Os must be three-stated prior to the presentation of data to $\mathrm{DQ}_{[15: 0]}$ and $\mathrm{DP}_{[1: 0]}$. As a safety precaution, the data lines are three-stated once a write cycle is detected, regardless of the state of $\overline{\mathrm{OE}}$.

## Single Read Accesses

A single read access is initiated when the following conditions are satisfied at clock rise: (1) $\overline{\mathrm{CE}}_{1}, \mathrm{CE}_{2}$, and $\overline{\mathrm{CE}}_{3}$ are all asserted active, and (2) $\overline{\operatorname{ADSP}}$ or $\overline{\text { ADSC }}$ is asserted LOW (if the access is initiated by ADSC, the write inputs must be deasserted during this first cycle). The address presented to the address inputs is latched into the Address Register, burst counter /control logic and presented to the memory core. If the OE input is asserted LOW, the requested data will be available at
the data outputs a maximum to $T_{C D V}$ after clock rise. $\overline{\mathrm{ADSP}}$ is ignored if CE1 is HIGH.

## Burst Sequences

This family of devices provide a 2-bit wrap around burst counter inside the SRAM. The burst counter is fed by $\mathrm{A}_{[1: 0]}$, and can follow either a linear or interleaved burst order. The burst order is determined by the state of the MODE input. A LOW on MODE will select a linear burst sequence. A HIGH on MODE will select an interleaved burst order. Leaving MODE unconnected will cause the device to default to a interleaved burst sequence.

Table 1. Counter Implementation for the Intel Pentium ${ }^{\circledR} / 80486$ Processor's Sequence

| First <br> Address | Second <br> Address | Third <br> Address | Fourth <br> Address |
| :---: | :---: | :---: | :---: |
| $\mathbf{A}_{\mathbf{X}+\mathbf{1}}, \mathbf{A}_{\mathbf{X}}$ | $\mathbf{A}_{\mathbf{X}+\mathbf{1}}, \mathbf{A}_{\mathbf{X}}$ | $\mathbf{A}_{\mathbf{X}+\mathbf{1}}, \mathbf{A}_{\mathbf{X}}$ | $\mathbf{A}_{\mathbf{X}+\mathbf{1}}, \mathbf{A}_{\mathbf{X}}$ |
| 00 | 01 | 10 | 11 |
| 01 | 00 | 11 | 10 |
| 10 | 11 | 00 | 01 |
| 11 | 10 | 01 | 00 |

Table 2. Counter Implementation for a Linear Sequence

| First <br> Address | Second <br> Addres | Third <br> Address | Fourth <br> Address |
| :---: | :---: | :---: | :---: |
| $\mathbf{A}_{\mathbf{X + 1}}, \mathbf{A}_{\mathbf{X}}$ | $\mathbf{A}_{\mathbf{X + 1},}, \mathbf{A}_{\mathbf{x}}$ | $\mathbf{A}_{\mathbf{X}+\mathbf{1}}, \mathbf{A}_{\mathbf{x}}$ | $\mathbf{A}_{\mathbf{X}+\mathbf{1}}, \mathbf{A}_{\mathbf{x}}$ |
| 00 | 01 | 10 | 11 |
| 01 | 10 | 11 | 00 |
| 10 | 11 | 00 | 01 |
| 11 | 00 | 01 | 10 |

## Sleep Mode

The ZZ input pin is an asynchronous input. Asserting ZZ HIGH places the SRAM in a power conservation "sleep" mode. Two clock cycles are required to enter into or exit from this "sleep" mode. While in this mode, data integrity is guaranteed. Accesses pending when entering the "sleep" mode are not considered valid nor is the completion of the operation guaranteed. The device must be deselected prior to entering the "sleep" mode. $\overline{\mathrm{CE}}_{1}, \mathrm{CE}_{2}, \overline{\mathrm{CE}}_{3}, \overline{\mathrm{ADSP}}$, and $\overline{\mathrm{ADSC}}$ must remain inactive for the duration of $\mathrm{t}_{\text {ZZREC }}$ after the ZZ input returns LOW.

Cycle Description Table ${ }^{[1,2,3]}$

| Cycle Description | ADD Used | $\overline{C E}_{1}$ | $\overline{C E}_{3}$ | $\mathrm{CE}_{2}$ | ZZ | $\overline{\text { ADSP }}$ | $\overline{\text { ADSP }}$ | $\overline{\text { ADV }}$ | $\overline{\text { WE }}$ | $\overline{\mathrm{OE}}$ | CLK | DQ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Deselected Cycle, Power-down | None | H | X | X | L | X | L | X | X | X | L-H | HIGH-Z |
| Deselected Cycle, Power-down | None | L | X | L | L | L | X | X | X | X | L-H | HIGH-Z |
| Deselected Cycle, Power-down | None | L | H | X | L | L | X | X | X | X | L-H | HIGH-Z |
| Deselected Cycle, Power-down | None | L | X | L | L | H | L | X | X | X | L-H | HIGH-Z |
| Deselected Cycle, Power-down | None | X | X | X | L | H | L | X | X | X | L-H | HIGH-Z |
| SNOOZE MODE, Power-Down | None | X | X | X | H | X | X | X | X | X | X | HIGH-Z |
| READ Cycle, Begin Burst | External | L | L | H | L | L | X | X | X | L | L-H | Q |
| READ Cycle, Begin Burst | External | L | L | H | L | L | X | X | X | H | L-H | HIGH-Z |
| WRITE Cycle, Begin Burst | External | L | L | H | L | H | L | X | L | X | L-H | D |
| READ Cycle, Begin Burst | External | L | L | H | L | H | L | X | H | L | L-H | Q |
| READ Cycle, Begin Burst | External | L | L | H | L | H | L | X | H | H | L-H | HIGH-Z |
| READ Cycle, Continue Burst | Next | X | X | X | L | H | H | L | H | L | L-H | Q |
| READ Cycle, Continue Burst | Next | X | X | X | L | H | H | L | H | H | L-H | HIGH-Z |
| READ Cycle, Continue Burst | Next | H | X | X | L | X | H | L | H | L | L-H | Q |
| READ Cycle, Continue Burst | Next | H | X | X | L | X | H | L | H | H | L-H | HIGH-Z |
| WRITE Cycle, Continue Burst | Next | X | X | X | L | H | H | L | L | X | L-H | D |
| WRITE Cycle, Continue Burst | Next | H | X | X | L | X | H | L | L | X | L-H | D |
| READ Cycle, Suspend Burst | Current | X | X | X | L | H | H | H | H | L | L-H | Q |
| READ Cycle, Suspend Burst | Current | X | X | X | L | H | H | H | H | H | L-H | HIGH-Z |
| READ Cycle, Suspend Burst | Current | H | X | X | L | X | H | H | H | L | L-H | Q |
| READ Cycle, Suspend Burst | Current | H | X | X | L | X | H | H | H | H | L-H | HIGH-Z |
| WRITE Cycle, Suspend Burst | Current | X | X | X | L | H | H | H | L | X | L-H | D |
| WRITE Cycle, Suspend Burst | Current | H | X | X | L | X | H | H | L | X | L-H | D |

Notes:

1. $\mathrm{X}=$ Don't Care, $1=$ Logic HIGH, $0=$ Logic LOW.
2. The SRAM always initiates a read cycle when $\overline{A D S P}$ asserted, regardless of the state of $\overline{\mathrm{GW}}, \overline{\mathrm{BWE}}$, or $\overline{\mathrm{BWS}}_{[1 ; 0]}$. Writes may occur only on subsequent clocks after the $\overline{\text { ADSP }}$ or with the assertion of $\overline{\text { ADSC. As a result, } \overline{\mathrm{OE}} \text { must be driven HIGH prior to the start of the write cycle to allow the outputs to three- state. OE }}$ is a don't care for the remainder of the write cycle.
3. $\overline{\mathrm{OE}}$ is asynchronous and is not sampled with the clock rise. During a read cycle $\mathrm{DQ}=\mathrm{HIGH}-\mathrm{Z}$ when $\overline{\mathrm{OE}}$ is inactive, and $\mathrm{DQ}=$ data when $\overline{\mathrm{OE}}$ is active

## Pin Descriptions

| TQFP Pin Number | Name | I/O | Description |
| :---: | :---: | :---: | :---: |
| 85 | $\overline{\text { ADSC }}$ | InputSynchronous | Address Strobe from Controller, sampled on the rising edge of CLK. When asserted LOW, $A_{[17: 0]}$ is captured in the address registers. $\mathrm{A}_{[1: 0]}$ are also loaded into the burst counter. When $\overline{\mathrm{ADSP}}$ and $\overline{\mathrm{ADSC}}$ are both asserted, only $\overline{\mathrm{ADSP}}$ is recognized. |
| 84 | $\overline{\text { ADSP }}$ | InputSynchronous | Address Strobe from Processor, sampled on the rising edge of CLK. When asserted LOW, $\mathrm{A}_{[17: 0]}$ is captured in the address registers. $\mathrm{A}_{[1: 0]}$ are also loaded into the burst counter. When $\overline{\mathrm{ADSP}}$ and $\overline{\mathrm{ADSC}}$ are both asserted, only $\overline{\mathrm{ADSP}}$ is recognized. $\overline{\mathrm{ASDP}}$ is ignored when $\overline{\mathrm{CE}}_{1}$ is deasserted HIGH. |
| 36, 37 | $\mathrm{A}_{[1: 0]}$ | InputSynchronous | $\mathrm{A}_{1}, \mathrm{~A}_{0}$ address inputs, These inputs feed the on-chip burst counter as the LSBs as well as being used to access a particular memory location in the memory array. |

Pin Descriptions (continued)

| $\begin{aligned} & \text { 50-44, } \\ & 80-82,99, \\ & 100, \\ & 32-35 \end{aligned}$ | $\mathrm{A}_{\text {[17:2] }}$ | InputSynchronous | Address Inputs used in conjunction with $\mathrm{A}_{[1: 0]}$ to select one of the 256 K address locations. Sampled at the rising edge of the CLK, if $\overline{\mathrm{CE}}_{1}, \mathrm{CE}_{2}$, and $\mathrm{CE}_{3}$ are sampled active, and $\overline{\text { ADSP }}$ or $\overline{\text { ADSC }}$ is active LOW. |
| :---: | :---: | :---: | :---: |
| 94, 93 | $\overline{\operatorname{BWS}}_{[1: 0]}$ | InputSynchronous | Byte Write Select Inputs, active LOW. Qualified with $\overline{\text { BWE }}$ to conduct byte writes. Sampled on the rising edge. $\overline{\mathrm{BWS}}_{0}$ controls $\mathrm{DQ}_{[7: 0]}$ and $\mathrm{DP}_{0}, \overline{\mathrm{BWS}}_{1}$ controls $\mathrm{DQ}_{[15: 8]}$ and $\mathrm{DP}_{1}$. See write table for further details. |
| 83 | $\overline{\text { ADV }}$ | InputSynchronous | Advance input used to advance the on-chip address counter. When LOW the internal burst counter is advanced in a burst sequence. The burst sequence is selected using the MODE input. |
| 87 | $\overline{\text { BWE }}$ | InputSynchronous | Byte Write Enable Input, active LOW. Sampled on the rising edge of CLK. This signal must be asserted LOW to conduct a byte write. |
| 88 | $\overline{\mathrm{GW}}$ | InputSynchronous | Global Write Input, active LOW. Sampled on the rising edge of CLK. This signal is used to conduct a global write, independent of the state of BWE and $\overline{\text { BWS }}_{[1: 0]}$. Global writes override byte writes. |
| 89 | CLK | Input-Clock | Clock input. Used to capture all synchronous inputs to the device. |
| 98 | $\overline{\mathrm{CE}}_{1}$ | InputSynchronous | Chip Enable 1 Input, active LOW. Sampled on the rising edge of CLK. Used in conjunction with $\mathrm{CE}_{2}$ and $\overline{\mathrm{CE}}_{3}$, to select/deselect the device. $\overline{\mathrm{CE}}_{1}$ gates $\overline{\mathrm{ADSP}}$. |
| 97 | $\mathrm{CE}_{2}$ | InputSynchronous | Chip Enable 2 Input, active HIGH. Sampled on the rising edge of CLK. Used in conjunction with $\overline{\mathrm{CE}}_{1}$ and $\overline{\mathrm{CE}}_{3}$ to select/deselect the device. |
| 92 | $\overline{\mathrm{CE}}_{3}$ | InputSynchronous | Chip Enable 3 Input, active LOW. Sampled on the rising edge of CLK. Used in conjunction with $\mathrm{CE}_{1}$ and $\mathrm{CE}_{2}$ to select/deselect the device. |
| 86 | $\overline{\text { OE }}$ | InputAsynchronous | Output Enable, asynchronous input, active LOW. Controls the direction of the I/O pins. When LOW, the I/O pins behave as outputs. When deasserted HIGH, I/O pins are three-stated, and act as input data pins. |
| 64 | ZZ | InputAsynchronous | Snooze input. Active HIGH asynchronous. When HIGH, the device enters a low power standby mode in which all other inputs are ignored, but the data in the memory array is maintained.Leaving ZZ floating or NC will default the device into an active state. |
| 31 | MODE | - | Mode input. Selects the burst order of the device. Tied HIGH selects the interleaved burst order. Pulled LOW selects the linear burst order. When left floating or NC, defaults to interleaved burst order. |
| $\begin{aligned} & 23,22,19, \\ & 18,13,12, \\ & 9,8,73, \\ & 72,69,68, \\ & 63,62,59, \\ & 58 \end{aligned}$ | $\mathrm{DQ}_{[15: 0]}$ | I/O- <br> Synchronous | Bidirectional Data I/O lines. As inputs, they feed into an on-chip data register that is triggered by the rising edge of CLK. As outputs, they deliver the data contained in the memory location specified by $\mathrm{A}_{[17: 0]}$ during the previous clock rise of the read cycle. The direction of the pins is controlled by $\overline{\mathrm{OE}}$ in conjunction with the internal control logic. When $\overline{\mathrm{OE}}$ is asserted LOW, the pins behave as outputs. When HIGH, $\mathrm{DQ}_{[15: 0]}$ and $\mathrm{DP}_{[1: 0]}$ are placed in a three-state condition. The outputs are automatically three-stated when a WRITE cycle is detected. |

Pin Descriptions (continued)

| 74, 24 | $\mathrm{DP}_{[1: 0]}$ | I/O- <br> Synchronous | Bidirectional Data Parity lines. These behave identical to $\mathrm{DQ}_{[15: 0]}$ described above. These signals can be used as parity bits for bytes 0 and 1 respectively. |
| :---: | :---: | :---: | :---: |
| $\begin{aligned} & \text { 15, 41, 65, } \\ & 91 \end{aligned}$ | $\mathrm{V}_{\mathrm{DD}}$ | Power Supply | Power supply inputs to the core of the device. Should be connected to 3.3 V power supply. |
| $\begin{aligned} & 5,10,17, \\ & 21,26,40, \\ & 55,60,67, \\ & 71,76,90 \end{aligned}$ | $\mathrm{V}_{\text {SS }}$ | Ground | Ground for the device. Should be connected to ground of the system. |
| $\begin{aligned} & 4,11,20, \\ & 27,54,61, \\ & 70,77 \end{aligned}$ | $V_{\text {DDQ }}$ | I/O Power Supply | Power supply for the I/O circuitry. Should be connected to a 2.5 or 3.3V power supply. |
| $\begin{aligned} & \hline 1-3,6,7, \\ & 14,16,25, \\ & 28-30, \\ & 51-53,56, \\ & 57,66,75, \\ & 78,79, \\ & 95-96 \end{aligned}$ | NC | - | No connects. |
| $\begin{aligned} & 38,39,42, \\ & 43 \end{aligned}$ | DNU | - | Do not use pins. Should be left unconnected or tied LOW. |

Write Cycle Descriptions ${ }^{[1,2,3,4]}$

| Function | $\overline{\mathrm{GW}}$ | $\overline{\text { BWE }}$ | $\overline{\text { BWS }}_{1}$ | $\overline{B W S}_{0}$ |
| :---: | :---: | :---: | :---: | :---: |
| Read | 1 | 1 | X | X |
| Read | 1 | 0 | 1 | 1 |
| Write Byte 0-DQ ${ }_{[7: 0]}$ and $\mathrm{DP}_{0}$ | 1 | 0 | 1 | 0 |
| Write Byte 1-DQ ${ }_{[15: 8]}$ and $\mathrm{DP}_{1}$ | 1 | 0 | 0 | 1 |
| Write All Bytes | 1 | 0 | 0 | 0 |
| Write All Bytes | 0 | X | X | X |

ZZ Mode Electrical Characteristics

| Parameter | Description | Test Conditions | Min | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{I}_{\mathrm{DDZZ}}$ | Snooze mode <br> standby current | $\mathrm{ZZ} \geq \mathrm{V}_{\mathrm{DD}}-0.2 \mathrm{~V}$ |  | 10 | mA |
| $\mathrm{I}_{\mathrm{DDZZ}}$ (L Version) | Snooze mode <br> standby current | $\mathrm{ZZ} \geq \mathrm{V}_{\mathrm{DD}}-0.2 \mathrm{~V}$ |  | 2 | mA |
| $\mathrm{t}_{\mathrm{ZZS}}$ | Device operation to <br> ZZ | $\mathrm{ZZ} \geq \mathrm{V}_{\mathrm{DD}}-0.2 \mathrm{~V}$ |  | $2 \mathrm{t}_{\mathrm{CYC}}$ | ns |
| $\mathrm{t}_{\mathrm{ZZREC}}$ | ZZ recovery time | $\mathrm{ZZ} \leq 0.2 \mathrm{~V}$ | $2 \mathrm{t}_{\mathrm{CYC}}$ |  | ns |

## Maximum Ratings

(Above which the useful life may be impaired. For user guidelines, not tested.)
Storage Temperature ................................... $65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Ambient Temperature with
Power Applied.
Supply Voltage on $\mathrm{V}_{\mathrm{DD}}$ Relative to GND............... -0.5 V to +4.6 V
DC Voltage Applied to Outputs
in High Z State ${ }^{[5]}$. $\qquad$ -0.5 V to $\mathrm{V}_{\mathrm{DD}}+0.5 \mathrm{~V}$

Current into Outputs (LOW)......................................... 20 mA
Static Discharge Voltage .......................................... >2001V
(per MIL-STD-883, Method 3015)
Latch-Up Current. $\qquad$ $>200 \mathrm{~mA}$

Operating Range

| Range | Ambient <br> Temperature | $\mathbf{V}_{\mathrm{DD}}$ | $\mathbf{V}_{\text {DDQ }}$ |
| :--- | :---: | :---: | :---: |
| Com'l | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 3.135 V to 3.6 V | 2.375 V to $\mathrm{V}_{\mathrm{DD}}$ |

## Notes:

4. When a write cycle is detected, all $I / O s$ are three-stated, even during byte writes.
5. Minimum voltage equals -2.0 V for pulse durations of less than 20 ns .
6. $\mathrm{T}_{\mathrm{A}}$ is the "instant on" case temperature.

Electrical Characteristics Over the Operating Range

| Parameter | Description | Test Conditions |  | 7C1325 |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min. | Max. |  |
| $\mathrm{V}_{\mathrm{OH}}$ | Output HIGH Voltage | $\mathrm{V}_{\mathrm{DDQ}}=3.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}=\mathrm{Min} ., \mathrm{l}_{\mathrm{OH}}=-4.0 \mathrm{~mA}$ |  | 2.4 |  | V |
|  |  | $\mathrm{V}_{\mathrm{DDQ}}=2.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}=\mathrm{Min} ., \mathrm{l}_{\mathrm{OH}}=-2.0 \mathrm{~mA}$ |  | 1.7 |  | V |
| $\mathrm{V}_{\mathrm{OL}}$ | Output LOW Voltage | $\mathrm{V}_{\mathrm{DDQ}}=3.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}=\mathrm{Min} ., \mathrm{l}$ OL $=8.0 \mathrm{~mA}$ |  |  | 0.4 | V |
|  |  | $\mathrm{V}_{\mathrm{DDQ}}=2.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}=\mathrm{Min} ., \mathrm{l} \mathrm{ILL}=2.0 \mathrm{~mA}$ |  |  | 0.7 | V |
| $\mathrm{V}_{\mathrm{IH}}$ | Input HIGH Voltage |  |  | 1.7 | $\begin{gathered} \hline \mathrm{V}_{\mathrm{DD}}+ \\ 0.3 \mathrm{~V} \end{gathered}$ | V |
| $\mathrm{V}_{\text {IL }}$ | Input LOW Voltage ${ }^{[5]}$ |  |  | -0.3 | 0.8 | V |
| $\mathrm{I}_{\mathrm{X}}$ | Input Load Current (except ZZ and MODE) | $\mathrm{GND} \leq \mathrm{V}_{\mathrm{I}} \leq \mathrm{V}_{\mathrm{DDQ}}$ |  | -1 | 1 | $\mu \mathrm{A}$ |
|  | Input Current of MODE | Input $=\mathrm{V}_{\text {SS }}$ |  | -30 |  | $\mu \mathrm{A}$ |
|  |  | Input = $\mathrm{V}_{\mathrm{DDQ}}$ |  |  | 5 | $\mu \mathrm{A}$ |
|  | Input Current of ZZ | Input $=\mathrm{V}_{\text {SS }}$ |  | -5 |  | $\mu \mathrm{A}$ |
|  |  | Input $=\mathrm{V}_{\mathrm{DDQ}}$ |  |  | 30 | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\mathrm{Oz}}$ | Output Leakage Current | GND $\leq \mathrm{V}_{1} \leq \mathrm{V}_{\mathrm{DD}}$, Output Disabled |  | -5 | 5 | $\mu \mathrm{A}$ |
| Ios | Output Short Circuit Current ${ }^{[7]}$ | $\mathrm{V}_{\text {DD }}=$ Max., $\mathrm{V}_{\text {OUT }}=\mathrm{GND}$ |  |  | -300 | mA |
| ${ }^{\text {DD }}$ | $\mathrm{V}_{\mathrm{DD}}$ Operating Supply Current | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=\text { Max., lout }=0 \mathrm{~mA}, \\ & \mathrm{f}=\mathrm{f}_{\mathrm{MAX}}=1 / \mathrm{t}_{\mathrm{CY}} . \end{aligned}$ | 8.5 ns cycle, 117 MHz |  | 350 | mA |
|  |  |  | 10 ns cycle, 100 MHz |  | 325 | mA |
|  |  |  | 11 ns cycle, 90 MHz |  | 300 | mA |
|  |  |  | 20 ns cycle, 50 MHz |  | 250 | mA |
| $\mathrm{I}_{\text {SB1 }}$ | Automatic CE Power-Down Current-TTL Inputs switching | Max. $\mathrm{V}_{\mathrm{DD}}$, Device Deselected, $\mathrm{V}_{\mathbb{I N}} \geq \mathrm{V}_{\mathbb{I}}$ or $\mathrm{V}_{\mathbb{I N}} \leq \mathrm{V}_{\mathrm{IL}}, \mathrm{f}=\mathrm{f}_{\mathrm{MAX}}$, inputs switching | 8.5 ns cycle, 117 MHz |  | 125 | mA |
|  |  |  | 10 ns cycle, 100 MHz |  | 110 | mA |
|  |  |  | 11 ns cycle, 90 MHz |  | 100 | mA |
|  |  |  | 20 ns cycle, 50 MHz |  | 75 | mA |
| $\mathrm{I}_{\text {SB2 }}$ | Automatic CE Power-Down Current - CMOS Inputs static | $\begin{aligned} & \text { Max. } \mathrm{V}_{\mathrm{DD}} \text {, Device Deselected, } \\ & \mathrm{V}_{\mathbb{I N}} \geq \mathrm{V}_{\mathrm{DD}}-0.3 \mathrm{~V} \text { or } \mathrm{V}_{\mathrm{IN}} \leq 0.3 \mathrm{~V}, \\ & \mathrm{f}=0 \text {, inputs static } \end{aligned}$ | Std version -All speeds |  | 10 | mA |
|  |  |  | L version -All speeds |  | 2 | mA |
| $\mathrm{I}_{\text {SB3 }}$ | Automatic CE Power-Down Current-CMOS Inputs switching, $\mathrm{F}=\mathrm{Max}$ | Max. $\mathrm{V}_{\mathrm{DD}}$, Device Deselected, $\mathrm{V}_{\mathbb{I N}} \geq \mathrm{V}_{\mathrm{DDQ}}-0.3 \mathrm{~V}$ or $\mathrm{V}_{\mathrm{IN}} \leq 0.3 \mathrm{~V}$, $\mathrm{f}=\mathrm{f}_{\mathrm{MAX}}$, inputs switching | 8.5 ns cycle, 117 MHz |  | 95 | mA |
|  |  |  | 10 ns cycle, 100 MHz |  | 85 | mA |
|  |  |  | 11 ns cycle, 90 MHz |  | 70 | mA |
|  |  |  | $20 \mathrm{~ns} \mathrm{cycle,50MHz}$ |  | 60 | mA |
| $I_{\text {SB4 }}$ | Automatic CE Power-Down Current <br> - CMOS Inputs static, F=Max | Max. $\mathrm{V}_{\mathrm{DD}}$, Device Deselected, $\mathrm{V}_{\mathbb{I}} \geq \mathrm{V}_{\mathrm{DD}}-0.3 \mathrm{~V}$ or $\mathrm{V}_{\mathbb{I}} \leq 0.3 \mathrm{~V}$, $\mathrm{f}=\mathrm{f}_{\mathrm{MAX}}$, inputs static | 8.5 ns cycle, 117 MHz |  | 60 | mA |
|  |  |  | 10 ns cycle, 100 MHz |  | 50 | mA |
|  |  |  | 11 ns cycle, 90 MHz |  | 40 | mA |
|  |  |  | 20 ns cycle, 50 MHz |  | 35 | mA |

## Capacitance ${ }^{[8]}$

| Parameter | Description | Test Conditions | Max. | Unit |
| :--- | :--- | :--- | :---: | :---: |
| $\mathrm{C}_{\mathbb{I N}}$ | Input Capacitance | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{f}=1 \mathrm{MHz}$, | 5.0 | pF |
| $\mathrm{C}_{/ / \mathrm{O}}$ | $\mathrm{V} / \mathrm{O}$ Capacitance | $\mathrm{V}_{\mathrm{DD}}=5.0 \mathrm{~V}$ | 8.0 | pF |

## Notes:

7. Not more than one output should be shorted at one time. Duration of the short circuit should not exceed 30 seconds.
8. Tested initially and after any design or process changes that may affect these parameters

## AC Test Loads and Waveforms



## Switching Characteristics Over the Operating Range ${ }^{[10]}$

| Parameter | Description | -117 |  | -100 |  | -90 |  | -50 |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Max. | Min. | Max. | Min. | Max. | Min. | Max. |  |
| $\mathrm{t}_{\mathrm{CYC}}$ | Clock Cycle Time | 8.5 |  | 10 |  | 11 |  | 20 |  | ns |
| ${ }^{\text {t }}$ CH | Clock HIGH | 3.0 |  | 4.0 |  | 4.5 |  | 4.5 |  | ns |
| $\mathrm{t}_{\mathrm{CL}}$ | Clock LOW | 3.0 |  | 4.0 |  | 4.5 |  | 4.5 |  | ns |
| $\mathrm{t}_{\text {AS }}$ | Address Set-Up Before CLK Rise | 2.0 |  | 2.0 |  | 2.0 |  | 2.0 |  | ns |
| $\mathrm{t}_{\mathrm{AH}}$ | Address Hold After CLK Rise | 0.5 |  | 0.5 |  | 0.5 |  | 0.5 |  | ns |
| $\mathrm{t}_{\text {CDV }}$ | Data Output Valid After CLK Rise |  | 7.5 |  | 8.0 |  | 8.5 |  | 11.0 | ns |
| $\mathrm{t}_{\text {DOH }}$ | Data Output Hold After CLK Rise | 2.0 |  | 2.0 |  | 2.0 |  | 2.0 |  | ns |
| $\mathrm{t}_{\text {ADS }}$ | $\overline{\text { ADSP, }}$ ADSC Set-Up Before CLK Rise | 2.0 |  | 2.0 |  | 2.0 |  | 2.0 |  | ns |
| $\mathrm{t}_{\text {ADH }}$ | $\overline{\text { ADSP, }} \overline{\text { ADSC }}$ Hold After CLK Rise | 0.5 |  | 0.5 |  | 0.5 |  | 0.5 |  | ns |
| twes | $\overline{\operatorname{BWS}}_{[1: 0]}, \overline{\mathrm{GW}}^{\text {, }} \overline{\mathrm{BWE}}$ Set-Up Before CLK Rise | 2.0 |  | 2.0 |  | 2.0 |  | 2.0 |  | ns |
| ${ }^{\text {t WEH }}$ | $\overline{\mathrm{BWS}}_{[1: 0]}, \overline{\mathrm{GW}}, \overline{\mathrm{BWE}}$ Hold After CLK Rise | 0.5 |  | 0.5 |  | 0.5 |  | 0.5 |  | ns |
| $\mathrm{t}_{\text {ADVS }}$ | $\overline{\text { ADV Set-Up Before CLK Rise }}$ | 2.0 |  | 2.0 |  | 2.0 |  | 2.0 |  | ns |
| $\mathrm{t}_{\text {ADVH }}$ | $\overline{\text { ADV Hold After CLK Rise }}$ | 0.5 |  | 0.5 |  | 0.5 |  | 0.5 |  | ns |
| $\mathrm{t}_{\text {DS }}$ | Data Input Set-Up Before CLK Rise | 2.0 |  | 2.0 |  | 2.0 |  | 2.0 |  | ns |
| $\mathrm{t}_{\mathrm{DH}}$ | Data Input Hold After CLK Rise | 0.5 |  | 0.5 |  | 0.5 |  | 0.5 |  | ns |
| $\mathrm{t}_{\text {CES }}$ | Chip Enable Set-Up | 2.0 |  | 2.0 |  | 2.0 |  | 2.0 |  | ns |
| $\mathrm{t}_{\text {CEH }}$ | Chip Enable Hold After CLK Rise | 0.5 |  | 0.5 |  | 0.5 |  | 0.5 |  | ns |
| ${ }^{\text {t }}$ CHZ | Clock to High-Z ${ }^{[11,12]}$ |  | 3.5 |  | 3.5 |  | 3.5 |  | 3.5 | ns |
| ${ }^{\text {t CLZ }}$ | Clock to Low-Z ${ }^{[11,12]}$ | 0 |  | 0 |  | 0 |  | 0 |  | ns |
| $\mathrm{t}_{\text {EOHz }}$ | $\overline{\mathrm{OE}}$ HIGH to Output High-Z ${ }^{[11,13]}$ |  | 3.5 |  | 3.5 |  | 3.5 |  | 3.5 | ns |
| teolz | $\overline{\mathrm{OE}}$ LOW to Output Low-Z ${ }^{[11,13]}$ | 0 |  | 0 |  | 0 |  | 0 |  | ns |
| teov | $\overline{\text { OE LOW to Output Valid }}$ |  | 3.5 |  | 3.5 |  | 3.5 |  | 3.5 | ns |

Notes:
9. $\mathrm{R} 1=1667 \Omega$ and $\mathrm{R} 2=1538 \Omega$ for $\mathrm{IOH} / \mathrm{IOL}=-4 / 8 \mathrm{~mA}, \mathrm{R} 1=521 \Omega$ and $\mathrm{R} 2=481 \Omega$ for $\mathrm{IOH} / \mathrm{IOL}=-2 / 2 \mathrm{~mA}$.
10. Unless otherwise noted, test conditions assume signal transition time of 2.5 ns or less, timing reference levels of 1.25 V , input pulse levels of 0 to 2.5 V , and output loading of the specified $\mathrm{I}_{\mathrm{OL}} / \mathrm{I}_{\mathrm{OH}}$ and load capacitance. Shown in (a) and (b) of AC test loads.
11. $t_{C H Z}, t_{C L Z}, t_{E O H Z}$, and $t_{E O L Z}$ are specified with a load capacitance of 5 pF as in part (b) of AC Test Loads. Transition is measured $\pm 200 \mathrm{mV}$ from steady-state voltage.
12. At any given voltage and temperature, $\mathrm{t}_{\mathrm{CHZ}}(\max )$ is less than $\mathrm{t}_{\mathrm{CLZ}}$ (min).
13. This parameter is sampled and not $100 \%$ tested.

## Timing Diagrams

## READ/WRITETiming



Device originally
deselected
$\overline{\mathrm{WE}}$ is the combination of $\overline{\mathrm{BWE}}, \overline{\mathrm{BWS}}_{[1: 0]}$ and $\overline{\mathrm{GW}}$ to define a write cycle (see write cycle definition table).
$\overline{\mathrm{CE}}$ is the combination of $\mathrm{CE}_{2}$ and $\overline{\mathrm{CE}}_{3}$. All chip selects need to be active in order to select the device. RAx stands for Read Address X, WA stands for Write Address X, Dx stands for Data-in X, Qx stands for Data-out X

```
        = DON'T CARE \square = UNDEFINED
```

Timing Diagrams (continued)
OE Switching Waveforms


Timing Diagrams (continued)


Notes:
14. Device must be deselected when entering ZZ mode. See Cycle description for all possible signal conditions to deselect the device.
15. I/Os are in three-state when exiting ZZ sleep mode.

## Ordering Information

| Speed <br> (MHz) | Ordering Code | Package <br> Name | Package Type | Operating <br> Range |
| :---: | :--- | :---: | :--- | :---: |
| 117 | CY7C1325-117AC | A101 | 100-Lead Thin Quad Flat Pack | Commercial |
| 117 | CY7C1325L-117AC | A101 | 100-Lead Thin Quad Flat Pack | Commercial |
| 100 | CY7C1325-100AC | A101 | 100-Lead Thin Quad Flat Pack | Commercial |
| 100 | CY7C1325L-100AC | A101 | 100-Lead Thin Quad Flat Pack | Commercial |
| 80 | CY7C1325-80AC | A101 | 100-Lead Thin Quad Flat Pack | Commercial |
| 80 | CY7C1325L-80AC | A101 | 100-Lead Thin Quad Flat Pack | Commercial |
| 50 | CY7C1325-50AC | A101 | 100-Lead Thin Quad Flat Pack | Commercial |
| 50 | CY7C1325L-50AC | A101 | 100-Lead Thin Quad Flat Pack | Commercial |

Document \#: 38-00652

## Package Diagram

100-Pin Thin Plastic Quad Flatpack ( $14 \times 20 \times 1.4 \mathrm{~mm}$ ) A101
DIMENSIINS ARE IN MILLIMETERS.


